

Appl. No. 10/034,079
Amdt. dated Jan. 22, 2004
Reply to Office Action of Oct. 24, 2003

Amendments to the Specification:

Please replace the paragraph beginning at page 16, line 18 with the following:

Related material is disclosed in U.S. Patent Application Serial No. _____ entitled ~~TARGETED BONDING FIBERS FOR STABILIZED ABSORBENT STRUCTURES~~ by F. Abuto et al., (attorney docket No. 15,708); in pending U.S. Patent Application Serial No. [[_____]] 10/034,021 entitled ABSORBENT STRUCTURES HAVING LOW MELTING FIBERS by J. Workman et al. (attorney docket No. 15,708B); ~~and~~ in pending U.S. Patent Application Serial No. [[_____]] 10/033,860 entitled TARGETED ON-LINE STABILIZED ABSORBENT STRUCTURES by F. Abuto et al., (attorney docket No. 17,527) ~~and ;~~ and in pending U.S. Patent Application Serial No. [[_____]] 10/037,385 entitled METHOD AND APPARATUS FOR MAKING ON-LINE STABILIZED ABSORBENT MATERIALS by T. Rymer et al. (attorney docket No. 16820), all of which were filed contemporaneously herewith on December 20th, 2001 (~~attorney docket No. 46820~~). The entire disclosures of these documents are incorporated herein by reference in a manner that is consistent herewith.